Product data sheet

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- · Low threshold voltage
- · Very fast switching
- Trench MOSFET technology
- · ElectroStatic Discharge (ESD) protection

3. Applications

- · Relay driver
- · High-speed line driver
- · Low-side loadswitch
- · Switching circuits

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit | |
|-------------------|----------------------------------|--|-----|-----|-----|-----|------|--|
| V _{DS} | drain-source voltage | T _j = 25 °C | | - | - | 60 | V | |
| V_{GS} | gate-source voltage | | | -20 | - | 20 | V | |
| I _D | drain current | V _{GS} = 10 V; T _{amb} = 25 °C | [1] | - | - | 190 | mA | |
| Static characte | Static characteristics | | | | | | | |
| R _{DSon} | drain-source on-state resistance | V_{GS} = 10 V; I_D = 190 mA; T_j = 25 °C | | - | 3 | 4.5 | Ω | |

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 1 cm².



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5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|----------------|
| 1 | G | gate | 3 | D I |
| 2 | S | source | | |
| 3 | D | drain | TO-236AB (SOT23) | G S 017aaa255 |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|-------------|----------|--|---------|--|--|--|
| | Name | Description | Version | | | |
| NX138AK | TO-236AB | plastic surface-mounted package; 3 leads | SOT23 | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code[1] |
|-------------|-----------------|
| NX138AK | AP% |

[1] % = placeholder for manufacturing site code

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|---|-----|-----|------|------|
| V_{DS} | drain-source voltage | T _j = 25 °C | | - | 60 | V |
| V _{GS} | gate-source voltage | | | -20 | 20 | V |
| I _D | drain current | V _{GS} = 10 V; T _{amb} = 25 °C | [1] | - | 190 | mA |
| | | V _{GS} = 10 V; T _{amb} = 100 °C | [1] | - | 120 | mA |
| I _{DM} | peak drain current | T_{amb} = 25 °C; single pulse; $t_p \le 10 \mu s$ | | - | 765 | mA |
| P _{tot} | total power dissipation | T _{amb} = 25 °C | [2] | - | 265 | mW |
| | | | [1] | - | 325 | mW |
| | | T _{sp} = 25 °C | | - | 1.33 | W |
| Tj | junction temperature | | | -55 | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |
| Source-drain | n diode | | | ' | | |
| I _S | source current | T _{amb} = 25 °C | [1] | - | 190 | mA |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 1 cm².
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

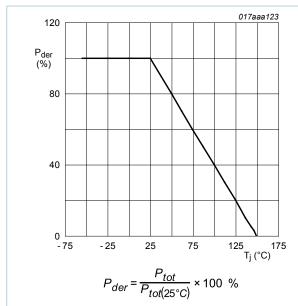


Fig. 1. Normalized total power dissipation as a function of junction temperature

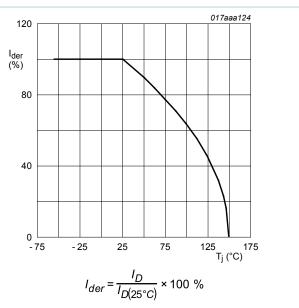


Fig. 2. Normalized continuous drain current as a function of junction temperature

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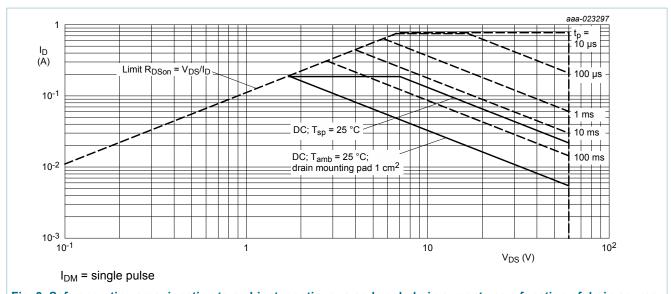


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------|--|------------|-----|-----|-----|-----|------|
| uig-a) | thermal resistance from junction to ambient | | [1] | - | 410 | 470 | K/W |
| | | | [2] | - | 330 | 380 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | | - | 80 | 95 | K/W |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

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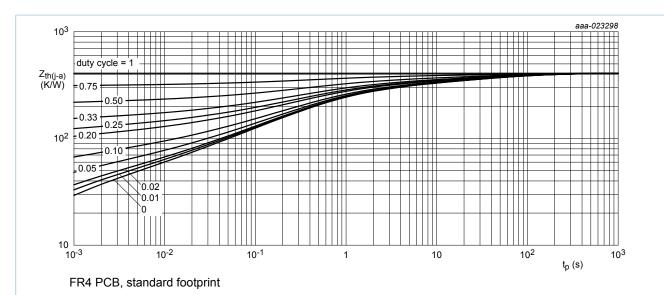


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

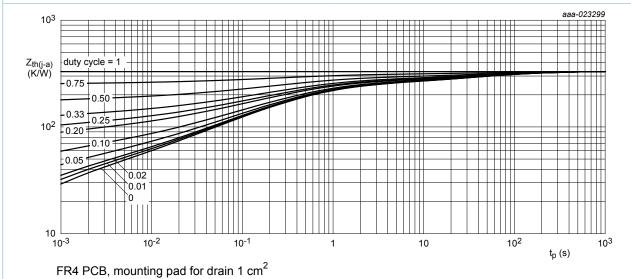


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-----------------------------------|--|-----|-----|------|------|
| Static chara | acteristics | | | | | _ |
| V _{(BR)DSS} | drain-source breakdown voltage | $I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$ | 60 | - | - | V |
| V_{GSth} | gate-source threshold voltage | $I_D = 250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$ | 0.8 | 1.1 | 1.5 | V |
| I _{DSS} | drain leakage current | V _{DS} = 60 V; V _{GS} = 0 V; T _j = 25 °C | - | - | 1 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C | - | - | 2 | μΑ |
| | | V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C | - | - | -2 | μΑ |
| | | V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C | - | - | 0.5 | μA |
| | | V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C | - | - | -0.5 | μΑ |
| | | V _{GS} = 5 V; V _{DS} = 0 V; T _j = 25 °C | - | - | 100 | nA |
| | | V _{GS} = -5 V; V _{DS} = 0 V; T _j = 25 °C | - | - | -100 | nA |
| R _{DSon} | drain-source on-state resistance | V_{GS} = 10 V; I_{D} = 190 mA; T_{j} = 25 °C | - | 3 | 4.5 | Ω |
| | | V _{GS} = 10 V; I _D = 190 mA; T _j = 150 °C | - | 6 | 9 | Ω |
| | | V _{GS} = 5 V; I _D = 170 mA; T _j = 25 °C | - | 4 | 5.2 | Ω |
| | | V_{GS} = 2.5 V; I_{D} = 130 mA; T_{j} = 25 °C | - | 5 | 10 | Ω |
| 9 _{fs} | forward transconductance | V_{DS} = 10 V; I_{D} = 180 mA; T_{j} = 25 °C | - | 3.5 | - | S |
| Dynamic ch | naracteristics | | | | | |
| Q _{G(tot)} | total gate charge | V _{DS} = 30 V; I _D = 190 mA; V _{GS} = 10 V; | - | 0.9 | 1.4 | nC |
| Q_{GS} | gate-source charge | T _j = 25 °C | - | 0.1 | - | nC |
| Q_{GD} | gate-drain charge | | - | 0.2 | - | nC |
| C _{iss} | input capacitance | $V_{DS} = 30 \text{ V}; f = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$ | - | 15 | 20 | pF |
| C _{oss} | output capacitance | T _j = 25 °C | - | 2.3 | - | pF |
| C _{rss} | reverse transfer capacitance | | - | 1.5 | - | pF |
| t _{d(on)} | turn-on delay time | V _{DS} = 30 V; I _D = 190 mA; V _{GS} = 10 V; | - | 8 | 12 | ns |
| t _r | rise time | $R_{G(ext)} = 75 \Omega; T_j = 25 ^{\circ}C$ | - | 10 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 8 | 20 | ns |
| t _f | fall time | | - | 5 | - | ns |
| Source-dra | in diode | | ' | , | , | |
| V _{SD} | source-drain voltage | I_S = 190 mA; V_{GS} = 0 V; T_j = 25 °C | - | 0.8 | 1.2 | V |
| | | | | | | |

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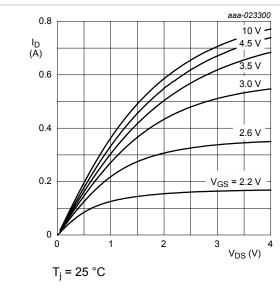


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

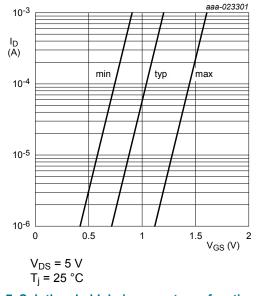


Fig. 7. Sub-threshold drain current as a function of gatesource voltage

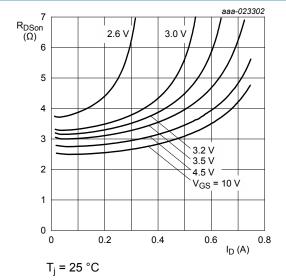


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

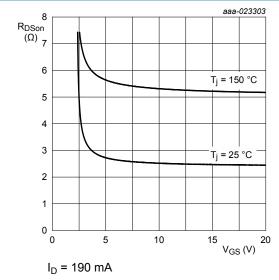


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

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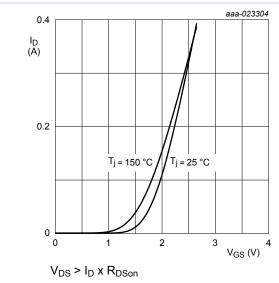


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

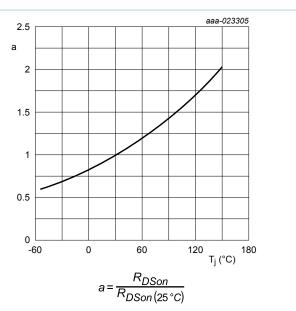


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

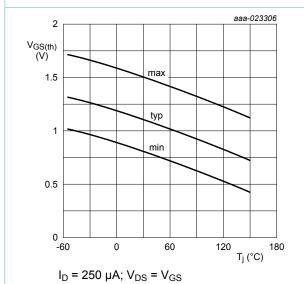


Fig. 12. Gate-source threshold voltage as a function of junction temperature

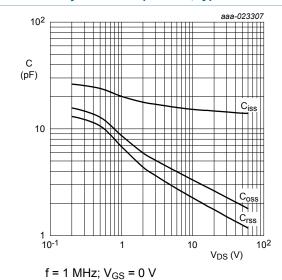


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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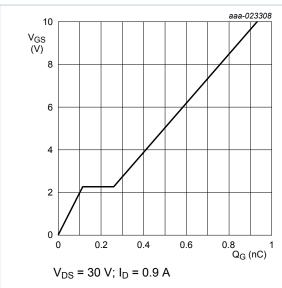


Fig. 14. Gate-source voltage as a function of gate charge; typical values

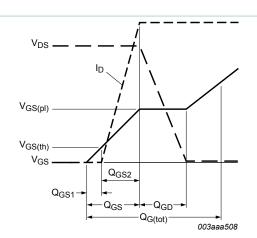


Fig. 15. MOSFET transistor: Gate charge waveform definitions

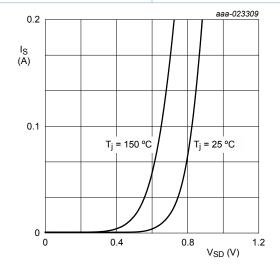
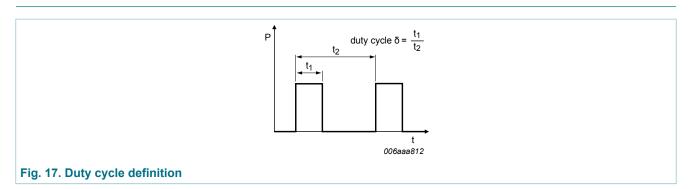


Fig. 16. Source current as a function of source-drain voltage; typical values

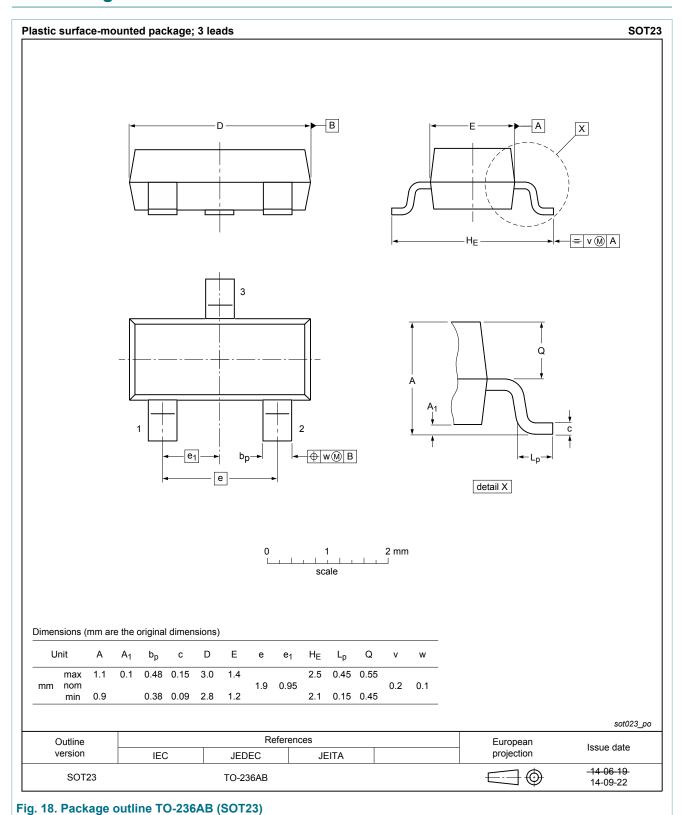
11. Test information

 $V_{GS} = 0 V$



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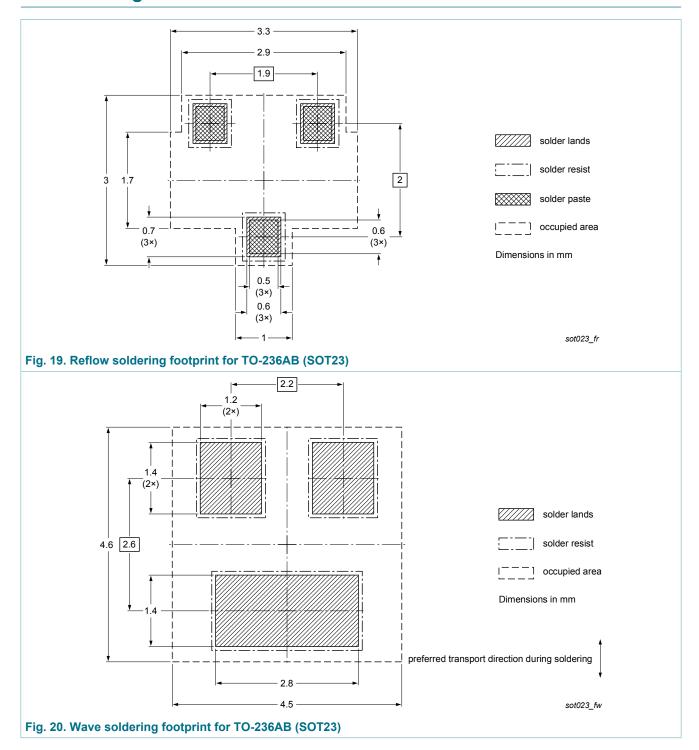
12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | | |
|----------------|-----------------|--|---------------|-------------|--|--|--|--|
| NX138AK v.2 | 20160610 | Product data sheet | - | NX138AK v.1 | | | | |
| Modifications: | Title changed f | Title changed for figures 11 and 12 to juction temperature | | | | | | |
| NX138AK v.1 | 20160607 | Product data sheet | - | - | | | | |

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---|
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